

High-Temperature Labeling

White Polyimide

Designed for Applications Where Intermittent Temperatures Can Reach 750°F (398°C)

*End Use Applications including:
Printed Circuit Board Labels
Component Tracking Labels*

For more information on FLEXcon's pressure-sensitive film solutions for High-Temperature Labeling, contact your local Sales Representative or our Product Identification Business Team at (508) 885-8300.

Product ID #: FLX050681



Product: FLEXcon® THERMLfilm® HT™ PI1W50G

Benefits:

- 1 mil polyimide film withstands intermittent heat up to 750°F (398°C) and printed circuit board cleaning environments

[Click here to view complete product data.](#)



FLEXcon® THERMLfilm® HT™ PI1W50G

PRODUCT DATA

VALUE

TEST METHOD

Product Performance and Suitability

All of the descriptive information, the typical performance data, and recommendations for the use of FLEXcon products shall be used only as a guide and do not reflect the specification or specification range for any particular property of the product. Furnishing such information is merely an attempt to assist you after you have indicated your contemplated use and shall in no event constitute a warranty of any kind by FLEXcon. All purchasers of FLEXcon products shall be responsible for independently determining the suitability of the material for the purpose for which it is purchased. No distributor, salesman, or representative of FLEXcon is authorized to give any warranty, guaranty, or make any representation in addition or contrary to the above.

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